CD22XXX Types

PREFIX DESIGNATION
for Intersil Telecom IC's

PART NUMBER

REVISION
A: 1st
B: 2nd etc.

SCREENING OPTION
X: Enhanced Product Screening i.e., Burn-In
(Optional for D, E Package Types)

PACKAGE DESIGNATOR
D: Ceramic Dual-In-Line Metal-Seal (SBDIP)
E: Dual-In-Line Plastic (PDIP)
F: Ceramic Dual-In-Line Frit-Seal (CERDIP)
M: Small Outline Plastic (SOIC)
Q: Plastic Leaded Chip Carrier (PLCC)
H: Chip

X Suffix Product Flow

STANDARD PRODUCT

100% BURN-IN 160 HR. AT +125°C OR EQUIVALENT

PRODUCTION STATE OR PROCESS

100% PARAMETRIC AND FUNCTIONAL TESTS AT +25°C

QUALITY ASSURANCE STEP

SAMPLE PARAMETRIC AND FUNCTIONAL TESTS AT +25°C
AQL = 0.025%

ENHANCED PRODUCT